

Using the HDF Bypass of the HSP43220

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When operated in the High Decimating Filter (HDF) bypass mode, the HSP43220 Decimating Digital Filter (DDF) requires clock timing relationships that are different from the normal operation configurations.

**Normal Operation**

Figure 1 illustrates the timing relationship between CLK\_IN, CK\_DEC and FIR\_CLK with the HDF configured for a decimation of 2. This is considered a “normal” operation mode.

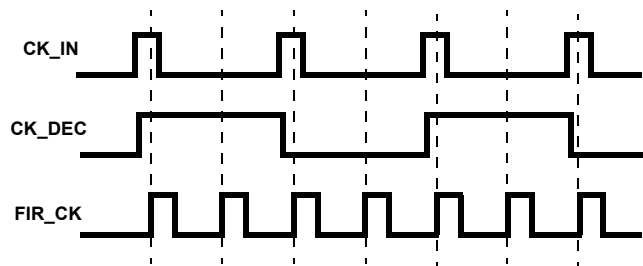


FIGURE 1. CIRCUIT TIMING WHEN H<sub>D</sub> = 2

The frequency of the CK\_IN signal is divided down by the HDF decimation counter to output CK\_DEC, which is at the decimated rate. The rising edge of the CK\_DEC is synchronized with FIR\_CLK and indicates that new data is ready at the output of the HDF, for use in the FIR filter. Figure 2 illustrates the block diagram implementation of this control signal.

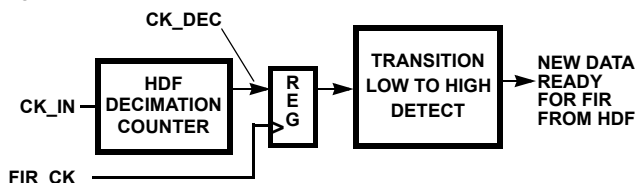


FIGURE 2. CK\_DEC GENERATION AND DETECTION

There are two timing considerations that must be considered for normal operation:

1.  $FIR\_CK \geq CK\_IN[(TAPS/2) + 4 + F_{DEC}]/[H_{DEC}F_{DEC}]$
2.  $CK\_IN/H_{DEC} \leq 4MHz$

**HDF Bypass Operation**

Figure 3 shows the detailed timing relationship between FIR\_CLK and CK\_IN required for the HDF bypass configuration. The HDF Section can be set for bypass operation (no decimation; H<sub>D</sub> = 1) by either setting the H\_BYP bit to 1 or by setting H\_DRATE = 0. Six timing specifications apply in the HDF bypass mode. For the 33MHz version of the part, the value of these parameters are:

- Clock Pulse Width High -  $t_{SPWH}$  ..... 13ns minimum
- Clock Skew Between CK\_IN and FIR\_CLK -  $t_{SK}$  ..... [t<sub>FIR</sub>-15] ns maximum
- CK\_IN Setup To FIR\_CLK -  $t_{CIS}$  ..... 17ns minimum
- CKIN Hold From FIR\_CLK -  $t_{CIH}$  ..... 2ns minimum
- CK\_IN Pulse Width Low -  $t_{CH1L}$  ..... 19ns minimum
- CK\_IN Pulse Width High -  $t_{CH1H}$  ..... 19ns minimum

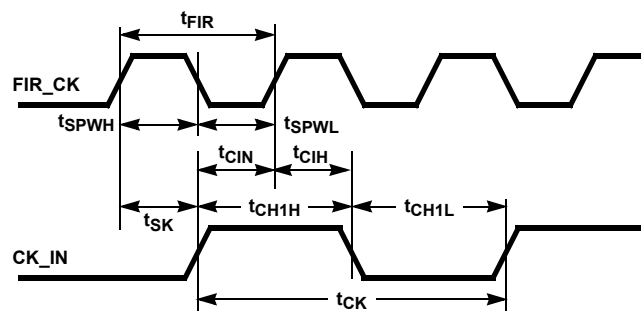


FIGURE 3. “NORMAL” OPERATION TIMING RELATIONSHIPS

Failure to meet the timing requirements on CK\_IN when H<sub>D</sub> = 1, results in either erratic or no DATA\_RDY pulses being issued.

Proper operation when H<sub>D</sub> = 1, requires two conditions:

1. **The FIR\_CLK should be at least 2 times the frequency of CK\_IN.**
2. **FIR\_CLK must also be synchronous to, and obey the setup and hold timing constraints with CK\_IN.**

Refer to the AC timing requirements table in the data sheet for values for t<sub>CIS</sub> and t<sub>CIH</sub>.

Ensuring that the CK\_DEC signal is sampled in both its high and low state by the flipflop requires careful control of CK\_IN. The most obvious solution is for the high or low time of CK\_IN to be a minimum of one period of FIR\_CLK. This guarantees sampling both a 1 and a 0, no matter what the phase relation of FIR\_CLK and CK\_IN is. Examples of timing that meet this condition are shown in Figures 5 and 6.

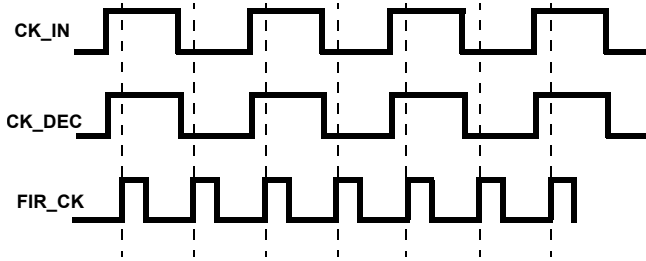


FIGURE 4. CIRCUIT TIMING - PROPER OPERATION ( $H_D = 1$ )  
WITH 50% DUTY CYCLE AND  $CK\_IN = FIR\_CK/2$

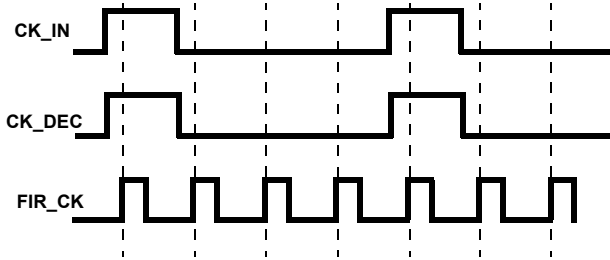


FIGURE 5. CIRCUIT TIMING - PROPER OPERATION ( $H_D = 1$ )  
WITH <50% DUTY CYCLE AND  $CK\_IN \leq FIR\_CK/2$

For applications where setting the period of CK\_IN fixed is not desirable, there is a specified range of allowed phase offset between FIR\_CK and CK\_IN in which the filter will operate in the HDF bypass mode. These are given in the AC Specifications. For the 33MHz speed version of the part, the parameters are:

CK\_IN Setup To FIR\_CLK -

$t_{CIS}$  ..... 17ns minimum

CKIN Hold From FIR\_CLK -

$t_{CIH}$  ..... 2ns minimum

CK\_IN Pulse Width Low -

$t_{CH1L}$  ..... 19ns minimum

CK\_IN Pulse Width High -

$t_{CH1H}$  ..... 19ns minimum

The phase difference between FIR\_CK and CK\_IN is defined as the clock skew, or  $t_{SK}$ . Using the  $t_{SK}$  specification and a 2ns margin, the minimum CK\_IN high or low times with setup and hold can be derived. These are shown in Figure 6.

For the 33MHz part, the minimum CK\_IN high or low time requirement is 19ns (when  $H_D = 1$ ) given the above timing (independent of clock frequencies).

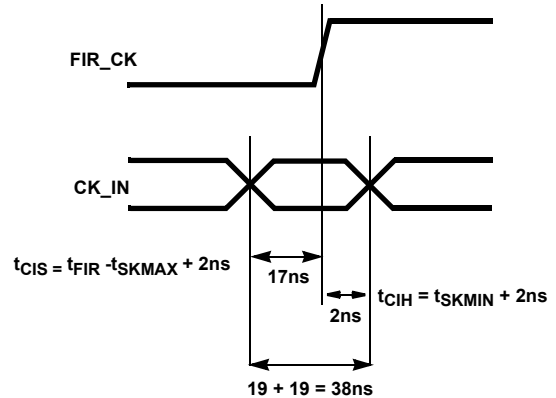


FIGURE 6.

### Summary for HDF Bypass Operation

For the typical user, setting the CK\_IN high and low times greater than or equal to the period of FIR\_CK will be the most desirable solution in terms of hardware.

For the user with additional system constraints, such as those that vary the frequency of CK\_IN, but hold constant the high or low time, the above timing yields the most flexible solution.

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